

To: Technology Center: 2186  
Facsimile Number: 703-872-9306

From: Robert D. Marshall, Jr.  
Texas Instruments Incorporated  
Facsimile: 972-917-4418  
Phone: 972-917-5290

Total Pages Sent: 6

RECEIVED  
CENTRAL FAX CENTER

JUL 06 2004

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of

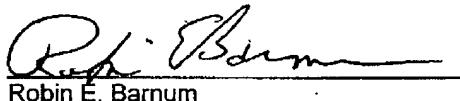
Gerard Chauvel, et al.  
Serial No.: 10/632,228  
Filed: July 31, 2003  
For: System and Method to Automatically Stack and Unstack Java Local Variables

TI-35422

Art Unit: 2186  
Examiner: Mano Padmanabhan  
Conf. No.: 2073

**OFFICIAL****CERTIFICATION OF FACSIMILE TRANSMISSION**

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-306-5995 on the date shown below:



Robin E. Barnum

July 6, 2004  
Date

**FACSIMILE COVER SHEET**

<input checked="" type="checkbox"/> <b>FACSIMILE COVER SHEET</b>	<input checked="" type="checkbox"/> <b>AMENDMENT</b>	<b>Prel Amt #2 (5 Pages)</b>
<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT	(# Page)
<input type="checkbox"/> DECLARATION (# Pages)	<input type="checkbox"/> NOTICE OF APPEAL (# Pages)	
<input checked="" type="checkbox"/> <b>ASSIGNMENT (2 Pages)</b>	<input type="checkbox"/> APPEAL	(# Pages)
<input type="checkbox"/> FORMAL DRAWINGS	<input type="checkbox"/> ISSUE FEE (# Pages)	
<input type="checkbox"/> INFORMAL DRAWINGS	<input type="checkbox"/> REPLY BRIEF (IN TRIPPLICATE) (# Pages)	
<input type="checkbox"/> CONTINUATION APPN (# Pages)	<input checked="" type="checkbox"/> Assignment Cover Sheet (1 page)	
<input type="checkbox"/> DIVISIONAL APPN		
NAME OF INVENTOR(S):		
Gerard Chauvel, et al.		
TITLE OF INVENTION: System and Method to Automatically Stack and Unstack Java Local Variables		
TI FILE NO.:	DEPOSIT ACCT. NO.:	RECEIPT DATE & SERIAL NO.:
TI-35422	20-0668	Serial No.: 10/632,228 Filing Date: July 31, 2003
FAXED:	7/6/04 (Tues. after Mon. Holiday)	
DUE:	7/4/04 (Sun. w/ Mon. Holiday)	
ATTY/SEC'Y:	RDM/reb	

This facsimile is intended only for the use of the address named and contains legally privileged and/or confidential information. If you are not the intended recipient of this telex, you are hereby notified that any dissemination, distribution, copying or use of this communication is strictly prohibited. Applicable privileges are not waived by virtue of the document having been transmitted by Facsimile. Any misdirected facsimiles should be returned to the sender by mail at the address indicated on this cover sheet.

Texas Instruments Incorporated  
PO Box 655474, M/S 3999  
Dallas, TX 75265

**BEST AVAILABLE COPY**